

HD74LS273

Octal D-type Positive-edge-triggered Flip-Flops (with Clear)

REJ03D0473-0300 Rev.3.00 Jul.15.2005

The HD74LS273, positive-edge-triggered flip-flops utilize LS TTL circuitry to implement D-type flip-flop logic with a direct clear input.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse.

When the clock input is at either the high or low level, the D input signal has no effect at the output.

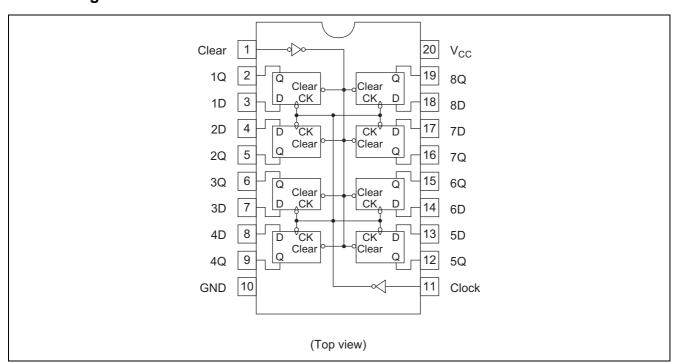
Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS273P	DILP-20 pin	PRDP0020AC-B (DP-20NEV)	Р	_
HD74LS273FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)
HD74LS273RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Function Table

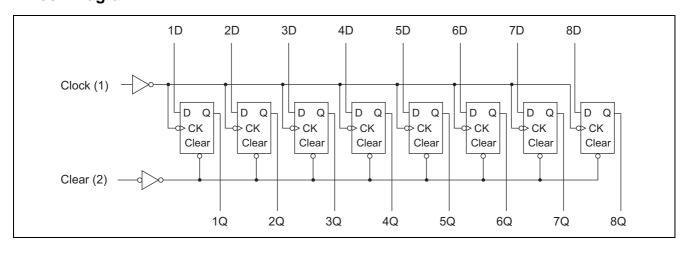
	Output		
Clear	Clock	D	Q
L	X	X	L
Н	1	Н	Н
Н	↑	L	L
Н	L	X	Q_0

Notes: H; high level, L; low level, X; irrelevant

1; transition from low to high level

Q₀; level of Q before the indicated steady-state input conditions were established.

Block Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V _{CC}	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P _T	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{cc}	4.75	5.00	5.25	V
Output ourrant	I _{OH}	_	_	-400	μΑ
Output current	I _{OL}	_	— -400 μA — 8 mA 25 75 °C — 30 MHz — ns — ns ns ns		
Operating temperature	Topr	-20	25	75	°C
Clock frequency	fclock	0	_	30	MHz
Clock pulse width	t _{w (clock)}	20	_	_	ns
Clear pulse width	t _{w (clear)}	20	_	_	ns
Data setup time	t _{su (data)}	20↑	_	_	ns
Clear (inactive-state) setup time	t _{su (clear)}	25↑	_	_	ns
Data hold time	t _{h (data)}	5↑	_	_	ns

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

Item	Symbol	min.	typ.*	max.	Unit	Condition	
Input voltage	V_{IH}	2.0	_	_	V		
Input voltage	V_{IL}	_	_	0.8	V		
Output valtage	V _{OH}	2.7			V	$V_{CC} = 4.75 \; V, \; V_{IH} = 2 \; V, \; V_{IL} = 0.8 \; V, \\ I_{OH} = -400 \; \mu A$	
Output voltage	V _{OL}			0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$	
				0.4		$I_{OL} = 4 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$	
	I _{IH}			20	μΑ	$V_{CC} = 5.25 \text{ V}, V_I = 2.7 \text{ V}$	
Input current	ᆜ			-0.4	mA	$V_{CC} = 5.25 \text{ V}, V_I = 0.4 \text{ V}$	
	1			0.1	mA	V _{CC} = 5.25 V, V _I = 7 V	
Short-circuit output current	los	-20	_	-100	mA	V _{CC} = 5.25 V	
Supply current	I _{CC} **	_	17	27	mA	V _{CC} = 5.25 V	
Input clamp voltage	V _{IK}	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$	

Notes: $^*V_{CC} = 5 \text{ V}$, $Ta = 25^{\circ}C$

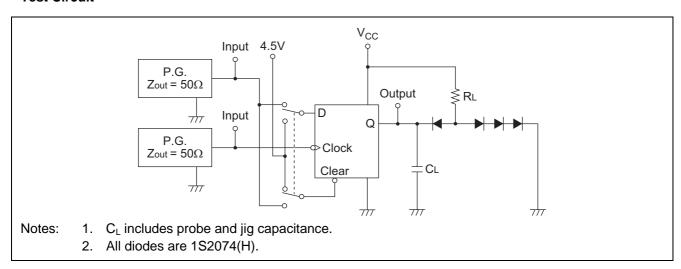
Switching Characteristics

 $(V_{CC} = 5 \text{ V}, \text{Ta} = 25^{\circ}\text{C})$

Item	Symbol	Inputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	$f_{\sf max}$	Clock	30	40	_	MHz	
Propagation delay time	t _{PHL}	Clear	_	18	27		C_L = 15 pF, R_L = 2 k Ω
	t _{PLH}	Clock	_	17	27	ns	
	t _{PHL}		_	18	27		

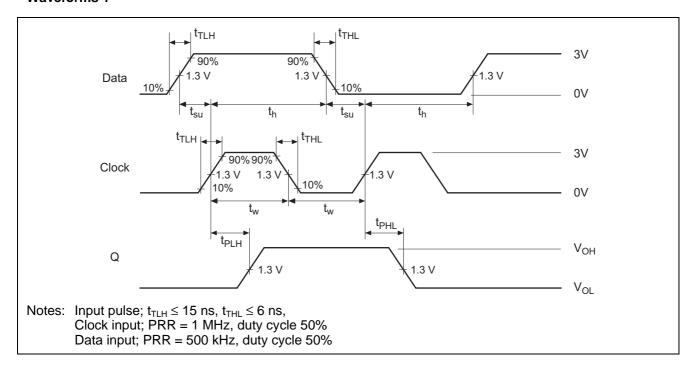
Testing Method

Test Circuit

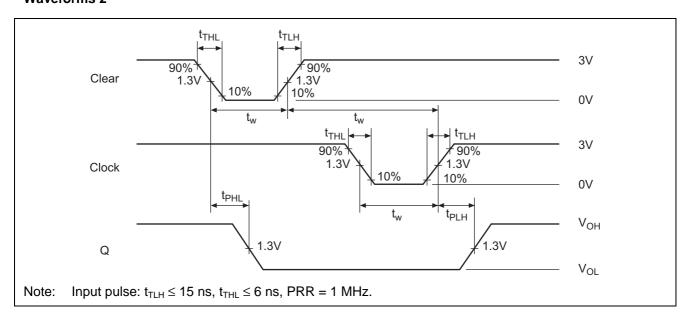


^{**} With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V is applied to clock.

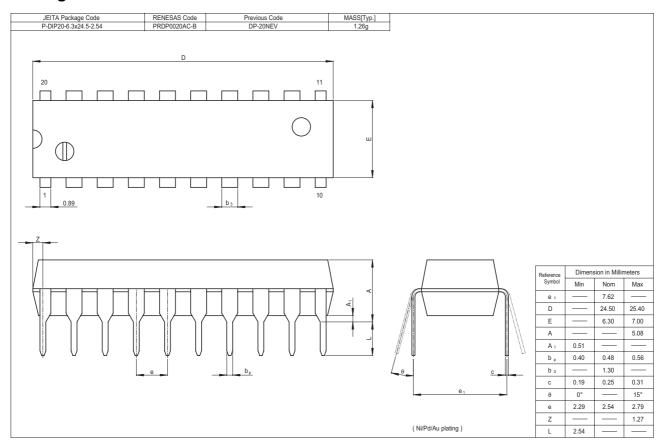
Waveforms 1

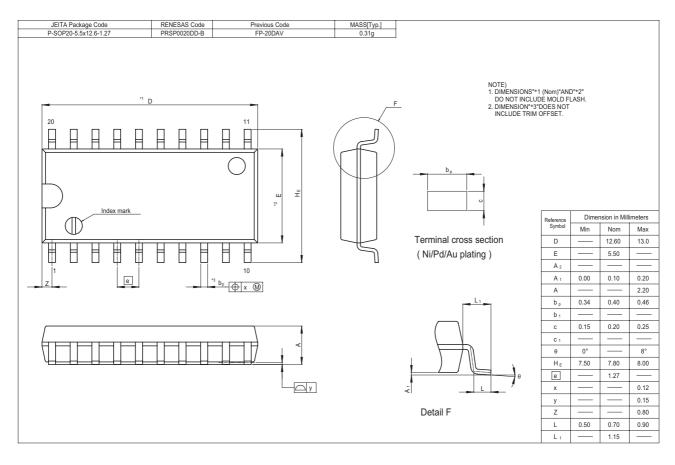


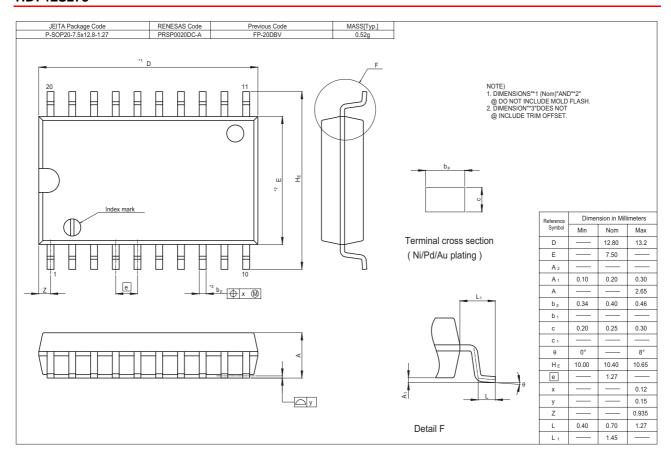
Waveforms 2



Package Dimensions







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